February 2001

FDG6306P

P-Channel 2.5V Specified PowerTrench^o MOSFET

General Description

This PChannel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications wth a wide range of gate drive voltage (2.5V - 12V).

Applications

- Battery management
- · Load switch

Features

- -0.6 A, -20 V. $R_{DS(ON)} = 420 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 630 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$
- Low gate charge
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Compact industry standard SC70-6 surface mount package



The pinouts are symmetrical; pin 1 and pin 4 are interchangeable.

Symbol	Parameter			Ratings	Units	
V _{DSS}	Drain-Source Voltage			-20	V	
V _{GSS}	Gate-Source Voltage			± 12	V	
b	Drain Current – Continuous (Note 1)			-0.6	A	
	– Pulsed			-2.0		
PD	Power Dissi	pation for Single Opera	ation (Note 1)	0.3	W	
T _J , T _{STG}	Operating a	nd Storage Junction Te	emperature Range	-55 to +150	°C	
R _{0JA}		sistance, Junction-to-A		415	°C/W	
rackay				T : 141	Quantity	
	Marking	Device	Reel Size	Tape width	Quantity	

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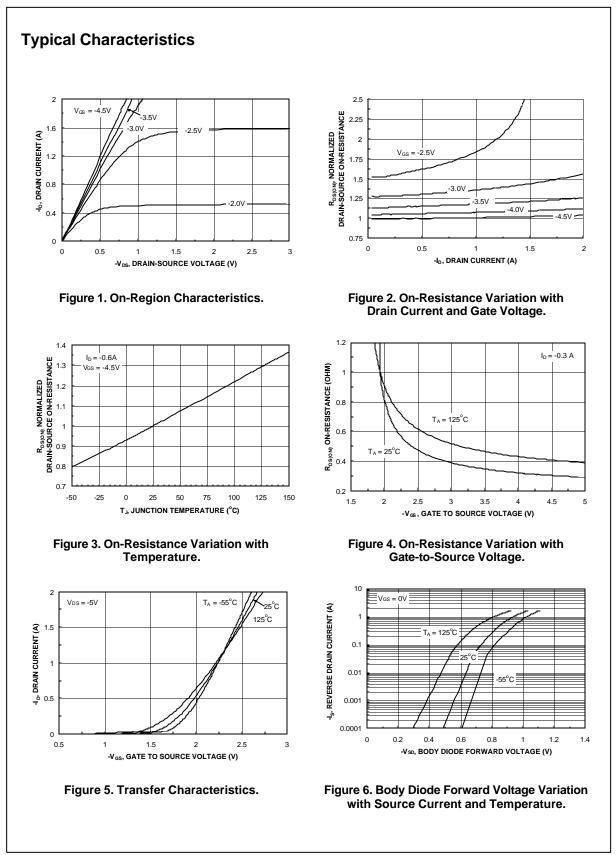
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Cha	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-14		mV/ºC
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = -12 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = 12 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Chai	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250 \; \mu\text{A}$	-0.6	-1.2	-1.5	V
<u>ΔVGS(th)</u> ΔTJ	Gate Threshold Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -4.5 \; V, \; I_D = -0.6 \; A \\ V_{GS} = -2.5 \; V, \; I_D = -0.5 \; A \\ V_{GS} = -4.5 \; V, \; I_D = -0.6 \; A, \; T_J {=} 125^\circ C \end{array} $		300 470 400	420 630 700	MΩ
D(on)	On–State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$	-2			A
FS	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -0.6 A$		1.8		S
Dynami	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		114		pF
Coss	Output Capacitance	f = 1.0 MHz		24		pF
Crss	Reverse Transfer Capacitance			9		pF
Switchi	ng Characteristics (Note 2)					
d(on)	Turn–On Delay Time	$V_{DD} = -10 V$, $I_D = 1 A$,		5.5	11	ns
r	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		14	25	ns
d(off)	Turn–Off Delay Time			6	12	ns
f	Turn–Off Fall Time			1.7	3.4	ns
Jg	Total Gate Charge	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -0.6 \text{ A},$		1.4	2.0	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = -4.5 V$		0.3		nC
⊋ _{gd}	Gate–Drain Charge			0.4		nC
Drain–S	ource Diode Characteristic	s and Maximum Ratings				
S	Maximum Continuous Drain–Source				-0.25	A
/ _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -0.25 A$ (Note 2)		-0.77	-1.2	V

R_{6JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reterence is defined as the solder mounting sum the drain pins. R_{6JA} is guaranteed by design while R_{6JA} is determined by the user's board design. R_{6JA} = 415°C/W when mounted on a minimum pad.

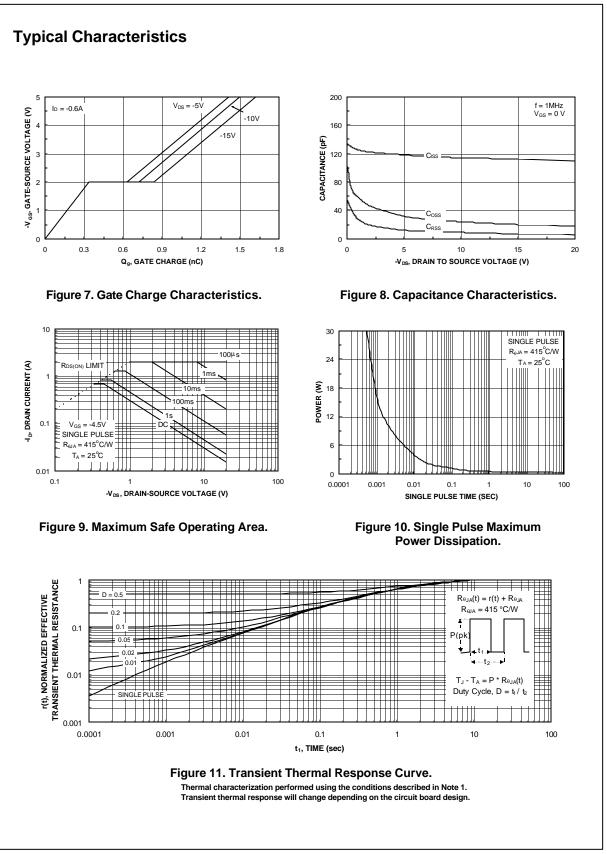
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDG6306P Rev C (W)

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